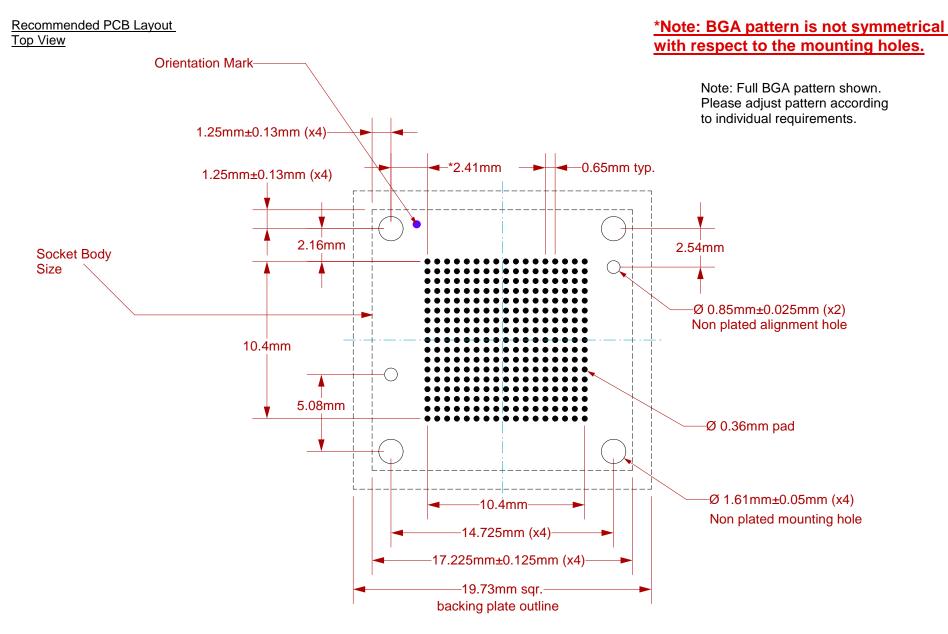


| SG-BGA-7036 Drawing  | Status: Released      | Scale         | : -       | Rev: B      | All tolerances: ±0.125mm (unless s otherwise). Materials and specifica |
|--|-----------------------|---------------|-----------|-------------|--|
| © 2009 IRONWOOD ELECTRONICS, INC.<br>11351 Rupp Drive, Suite 400, Burnsville, MN 55337 | Drawing: H. Hansen    | Date: 1/24/05 |           | 4/05        | are subject to change without notice                                   |
| Tele: (952) 229-8200<br>www.ironwoodelectronics.com                                    | File: SG-BGA-7036 Dwg |               | Modified: | 6/12/09, AE | PAGE 1 of 4  |

ances: ±0.125mm (unless stated se). Materials and specifications ject to change without notice.



## Target PCB Recommendations

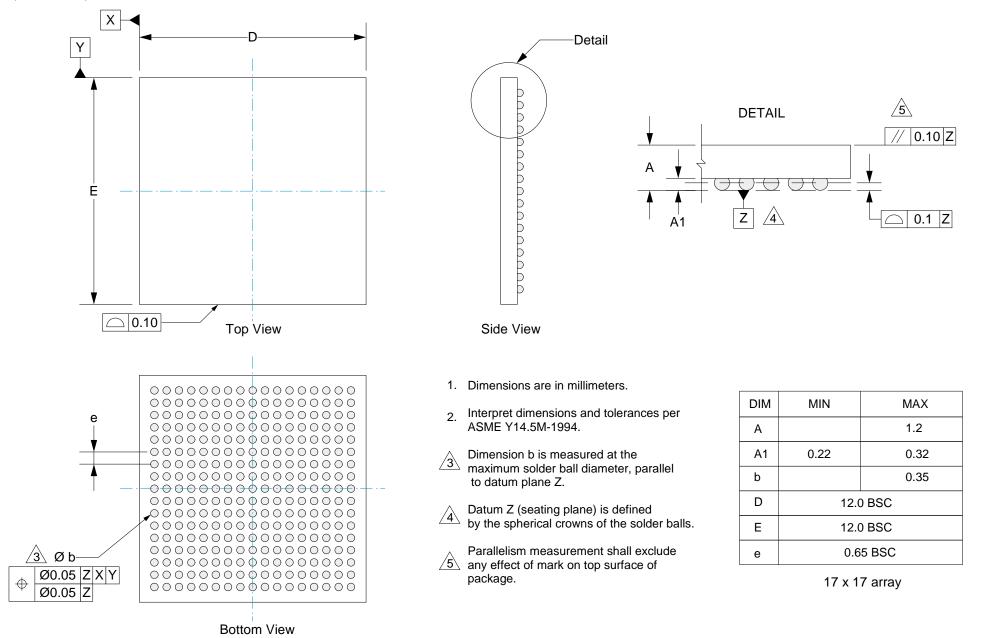
Total thickness: 1.6mm min. Plating: Gold or Solder finish PCB Pad height: Same or higher than solder mask

All dimensions are in mm unless stated otherwise

Recommended PCB Layout Tolerances: ±0.025mm [±0.001"] unless stated otherwise.

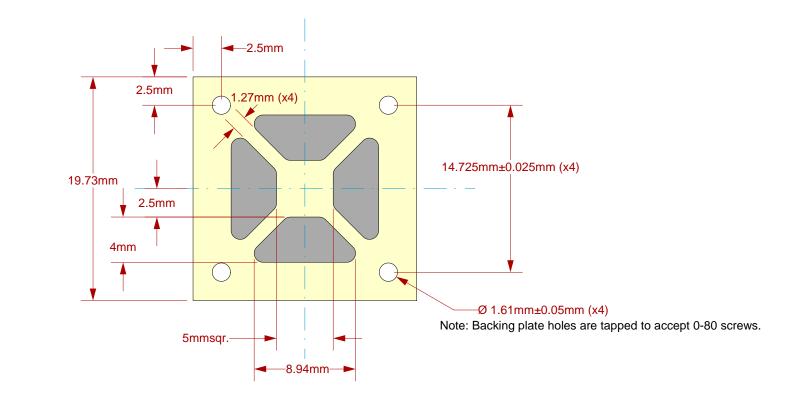
| SG-BGA-7036 Drawing  | Status: Released      | Scale: 4:1 |                       | Rev: B |  |
|--|-----------------------|------------|-----------------------|--------|--|
| © 2009 IRONWOOD ELECTRONICS, INC.<br>11351 Rupp Drive, Suite 400, Burnsville, MN 55337 | Drawing: H. Hansen    |            | Date: 1/24/05         |        |  |
| Tele: (952) 229-8200<br>www.ironwoodelectronics.com                                    | File: SG-BGA-7036 Dwg |            | Modified: 6/12/09, AE |        |  |

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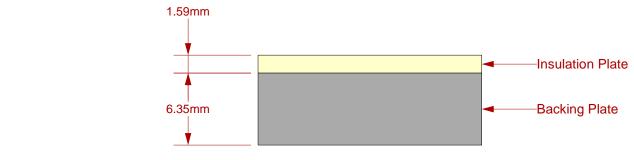


|  | SG-BGA-7036 Drawing   | Status: Released      | Scale | : 1:0.2               | Rev: B |  |
|--|---|-----------------------|-------|-----------------------|--------|--|
|  | © 2009 IRONWOOD ELECTRONICS, INC.<br>11351 Rupp Drive, Suite 400, Burnsville, MN 55337<br>Tele: (952) 229-8200<br>www.ironwoodelectronics.com | Drawing: H. Hansen    |       | Date: 1/24/05         |        |  |
|  |   | File: SG-BGA-7036 Dwg |       | Modified: 6/12/09, AE |        |  |

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Description: Insulation Plate and Backing Plate

| SG-BGA-7036 Drawing   | Status: Released      | Scale: 3:1 |                       | Rev: B |
|---|-----------------------|------------|-----------------------|--------|
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|   | File: SG-BGA-7036 Dwg |            | Modified: 6/12/09, AE |        |

All dimensions are in mm. All tolerences are +/- 0.125mm. (Unless stated otherwise)

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